

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	Semiconductor device and method of producing the same	
Application Number :		
Date :		
First Named Applicant:	Masaki Takaoka	
Confirmation Number:		
Attorney Docket Number:	RHM-US020052	
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Steven Roberts		SJR
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Documents being submitted:	Files
us-request	RHM-US020052-usrequ.xml us-request.dtd us-request.xsl
us-assignment	RHM-US020052-usassn.xml us-assignment.xsl us-assignment.dtd assign.tif
us-fee-sheet	RHM-US020052-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	spec-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd fig1A_1B.tif fig2A_2B_2C.tif fig3.tif fig4.tif fig5A_5B_5C_5D.tif fig6.tif fig7.tif fig8A_8B_8C_8D.tif fig8E_8F.tif fig9.tif fig10.tif

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	fig14.tif
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Comments	